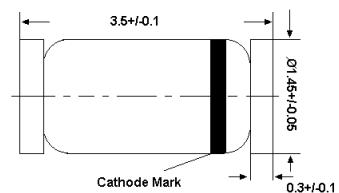


BAV101~BAV103

Silicon Epitaxial Planar Diodes

High Voltage Switching Diodes

LL-34



Glass case MiniMELF
Dimensions in mm

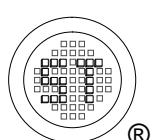
Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage BAV101 BAV102 BAV103	V_{RRM}	120	V
		200	
		250	
Reverse Voltage BAV101 BAV102 BAV103	V_R	100	V
		150	
		200	
Continuous Forward Current	I_F	250	mA
Repetitive Peak Forward Current	I_{FRM}	625	mA
Non-repetitive Peak Forward Surge Current at $t = 1 \text{ s}$ at $t = 100 \mu\text{s}$ at $t = 1 \mu\text{s}$	I_{FSM}	1	A
		3	
		9	
Total Power Dissipation	P_{tot}	400	mW
Junction Temperature	T_j	175	°C
Storage Temperature Range	T_{stg}	- 65 to + 175	°C

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance Junction to Ambient ¹⁾	$R_{\theta JA}$	375	°C/W

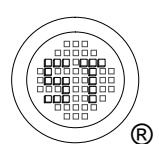
¹⁾ Valid provided that electrodes are kept at ambient temperature.



BAV101~BAV103

Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Max.	Unit
Forward Voltage at $I_F = 100 \text{ mA}$ at $I_F = 200 \text{ mA}$	V_F	1 1.25	V
Reverse Current at $V_R = 100 \text{ V}$ at $V_R = 150 \text{ V}$ at $V_R = 200 \text{ V}$ at $V_R = 100 \text{ V}, T_j = 150 \text{ }^\circ\text{C}$ at $V_R = 150 \text{ V}, T_j = 150 \text{ }^\circ\text{C}$ at $V_R = 200 \text{ V}, T_j = 150 \text{ }^\circ\text{C}$	I_R	100	nA
		100	nA
		100	nA
		100	μA
		100	μA
		100	μA
Diode Capacitance at $V_R = 0, f = 1 \text{ MHz}$	C_d	5	pF
Reverse Recovery Time at $I_F = I_R = 30 \text{ mA}, I_{rr} = 3 \text{ mA}, R_L = 100 \Omega$	t_{rr}	50	ns



BAV101~BAV103

Electrical Characteristics Curves

Fig 1. Derating Curve

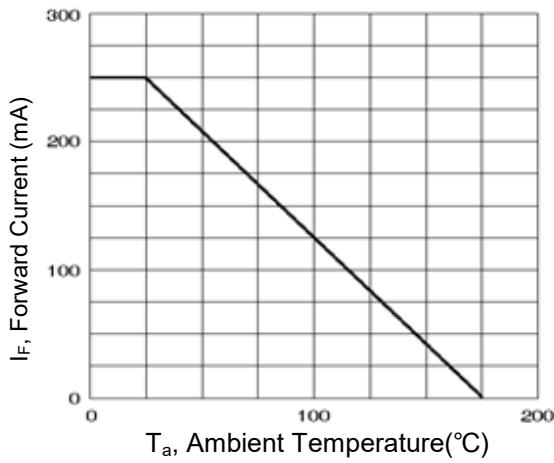


Fig 2. Forward Characteristics

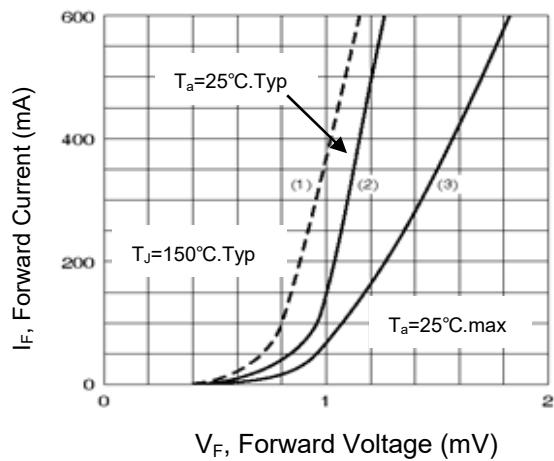


Fig 3. Cd vs. V_R

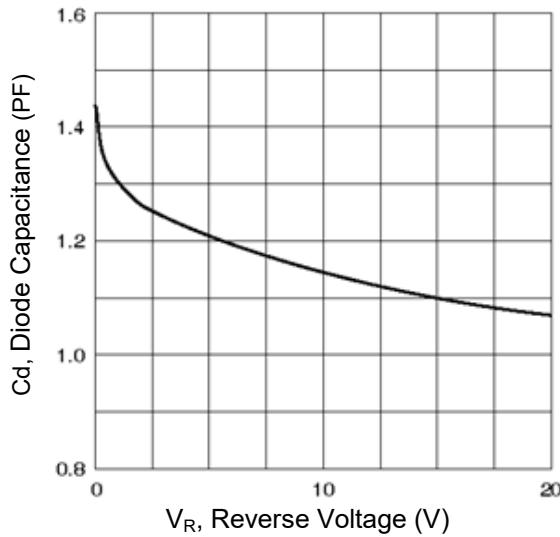


Fig 4. I_{FSM} vs. T_p

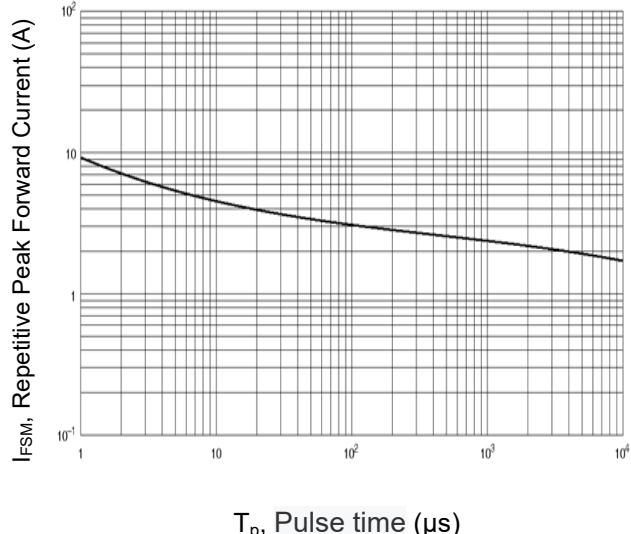


Fig 5. Reverse Characteristics

